PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHIGEO NAKAJIMA	03/03/2015
TAKAHIRO HISASUE	03/02/2015
KENJI EBARA	03/04/2015
YUKINORI NAKAMICHI	03/03/2015

RECEIVING PARTY DATA

Name:	ASAHI KASEI CHEMICALS CORPORATION
Street Address:	1-105, KANDA JINBOCHO, CHIYODA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	101-8101

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14416830

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	042715-5137
NAME OF SUBMITTER:	JANICE H. LEE
SIGNATURE:	/Janice H. Lee/
DATE SIGNED:	03/09/2015

Total Attachments: 4
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source=042715-5137-Assignment#page3.tif

ASSIGNMENT

WHEREAS WE, the below named inventors, (hereinafter referred to as "Assignors"), have made an invention entitled:

BLOCK COPOLYMER COMPOSITION FOR VISCOUS ADHESIVE, AND ADHESIVE COMPOSITION

for which WE filed an application for United States Letters Patent on [January 23,2015], (Application No. [14/416,830]); and

WHEREAS Asahi Kasei Chemicals Corporation whose post office address is 1-105, Kanda Jinbocho, Chiyoda-ku, Tokyo 101-8101 Japan and Japan Elastomer Co., Ltd whose post office address is 1-105, Kanda Jinbocho, Chiyoda-ku, Tokyo 101-8101 Japan (hereinafter referred to as "Assignee"), are desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Director of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, WE have hereunto set my hands.

Full Name of first Assignor	Shigeo NAKAJIMA
Address	1-105, Kanda Jinbocho, Chiyoda-ku, Tokyo 101-8101 Japan
Signature	Shigeo Nakajima
Date	March 3, 2015
Full Name of second Assignor	Takahiro HISASUE
Address	1-105, Kanda Jinbocho, Chiyoda-ku, Tokyo 101-8101 Japan
Signature	
Date	

ASSIGNMENT

WHEREAS WE, the below named inventors, (hereinafter referred to as "Assignors"), have made an invention entitled:

BLOCK COPOLYMER COMPOSITION FOR VISCOUS ADHESIVE, AND ADHESIVE COMPOSITION

for which WE filed an application for United States Letters Patent on [January 23,2015], (Application No. [14/416,830]); and

WHEREAS Asahi Kasei Chemicals Corporation whose post office address is 1-105, Kanda Jinbocho, Chiyoda-ku, Tokyo 101-8101 Japan and Japan Elastomer Co., Ltd whose post office address is 1-105, Kanda Jinbocho, Chiyoda-ku, Tokyo 101-8101 Japan (hereinafter referred to as "Assignee"), are desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Director of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, WE have hereunto set my hands.

Full Name of first Assignor	Shigeo NAKAJIMA
Address	1-105, Kanda Jinbocho, Chiyoda-ku, Tokyo 101-8101 Japan
Signature	
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Full Name of second Assignor	Takahiro HISASUE
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Signature	Takahiro Hisasue
Date	March 2, 2015

Full Name of third Assignor	Kenji EBARA
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Signature	Kenji Ebara
Date	March 4, 2015
Full Name of forth Assignor	Yukinori NAKAMICHI
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Signature	
Date	

Full Name of third Assignor	Kenji EBARA
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Signature	
Date	
Full Name of forth Assignor	Yukinori NAKAMICHI
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Signature	Yukinori Nakamichi
Date	March 3, 2015